

N-Channel Enhancement Mode Field Effect Transistor

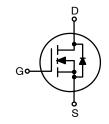
2N7000, 2N7002, NDS7002A

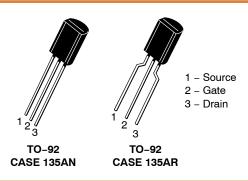
Description

These N-channel enhancement mode field effect transistors are produced using **onsemi**'s proprietary, high cell density, DMOS technology. These products have been designed to minimize on-state resistance while providing rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 400 mAdc and can deliver pulsed currents up to 2 A. These products are particularly suited for low-voltage, low-current applications, such as small servo motor control, power MOSFET gate drivers, and other switching applications.

Features

- High Density Cell Design for Low R_{DS(on)}
- Voltage Controlled Small Signal Switch
- Rugged and Reliable
- High Saturation Current Capability
- This Device is Pb-Free and Halogen Free





MARKING DIAGRAM



\$Y = **onsemi** Logo &Z = Assembly Plant Code

&3 = Date Code

2N7000 = Specific Device Code



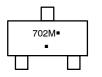
1 – Gate

2 - Source

3 – Drain

SOT-23 CASE 318-08

MARKING DIAGRAM



702 = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

ABSOLUTE MAXIMUM RATINGS Values are at T_C = 25°C unless otherwise noted.

| | | | Value | | |
|-----------------------------------|---|------------------------|-------|------|-------|
| Symbol | Parameter | 2N7000 2N7002 NDS7002A | | | Unit |
| V _{DSS} | Drain-to-Source Voltage | | 60 | | V |
| V _{DGR} | Drain-Gate Voltage (R _{GS} ≤ 1 MW) | | 60 | | V |
| V _{GSS} | Gate-Source Voltage - Continuous | ±20 | | | V |
| | Gate-Source Voltage - Non Repetitive (tp < 50 ms) | ±40 | | | |
| I _D | Maximum Drain Current - Continuous | 200 | 115 | 280 | mA |
| | Maximum Drain Current - Pulsed | 500 | 800 | 1500 | |
| P _D | Maximum Power Dissipation Derated above 25°C | 400 | 200 | 300 | mW |
| | | 3.2 | 1.6 | 2.4 | mW/°C |
| T _J , T _{STG} | Operating and Storage Temperature Range | -55 to 150 -65 to 150 | | °C | |
| TL | Maximum Lead Temperature for Soldering Purposes, 1/16-inch from Case for 10 s | 300 | | | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS Values are at $T_C = 25$ °C unless otherwise noted.

| | | Value | | | |
|-----------------|---|--------|--------|----------|------|
| Symbol | Parameter | 2N7000 | 2N7002 | NDS7002A | Unit |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 312.5 | 625 | 417 | °C/W |

ELECTRICAL CHARACTERISTICS

Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | Conditions | Туре | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---|--------------------|-----|-----|------|------|
| OFF CHARA | CTERISTICS | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} = 0 V, I _D = 10 μA | All | 60 | - | - | V |
| I _{DSS} | Zero Gate Voltage Drain | V _{DS} = 48 V, V _{GS} = 0 V | 2N7000 | - | _ | 1 | μΑ |
| | Current | V _{DS} = 48 V, V _{GS} = 0 V, T _C = 125°C | | - | - | 1 | mA |
| | | V _{DS} = 60 V, V _{GS} = 0 V 2N7002 | - | _ | 1 | μΑ | |
| | | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$ | NDS7002A | - | - | 0.5 | mA |
| I _{GSSF} | Gate – Body Leakage, | V _{GS} = 15 V, V _{DS} = 0 V | 2N7000 | - | _ | 10 | nA |
| | Forward | V _{GS} = 20 V, V _{DS} = 0 V | 2N7002 NDS7002A | - | - | 100 | |
| I _{GSSR} | Gate – Body Leakage, | V _{GS} = -15 V, V _{DS} = 0 V | 2N7000 | - | _ | -10 | nA |
| | Reverse | $V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$ | 2N7002 NDS7002A | - | - | -100 | |
| ON CHARAC | CTERISTICS | _ | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$ | 2N7000 | 0.8 | 2.1 | 3 | V |
| | | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2N7002 NDS7002A | 1 | 2.1 | 2.5 | |

ELECTRICAL CHARACTERISTICS (continued)

Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | Conditions | Туре | Min | Тур | Max | Unit |
|---------------------|---------------------------------|--|--------------------|-----|------|------|------|
| ON CHARAC | CTERISTICS | | | | | | |
| R _{DS(on)} | Static Drain-Source | V _{GS} = 10 V, I _D = 500 mA | 2N7000 | - | 1.2 | 5 | Ω |
| | On-Resistance | $V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA},$ $T_C = 125^{\circ}\text{C}$ | | - | 1.9 | 9 | |
| | | V _{GS} = 4.5 V, I _D = 75 mA | | - | 1.8 | 5.3 | |
| | | V _{GS} = 10 V, I _D = 500 mA | 2N7002 | _ | 1.2 | 7.5 | |
| | | $V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA},$ $T_C = 100^{\circ}\text{C}$ |] | - | 1.7 | 13.5 | |
| | | V _{GS} = 5 V, I _D = 50 mA | | _ | 1.7 | 7.5 | |
| | | $V_{GS} = 5 \text{ V, } I_D = 50 \text{ mA,}$ $T_C = 100^{\circ}\text{C}$ |] | - | 2.4 | 13.5 | |
| | | V _{GS} = 10 V, I _D = 500 mA | NDS7002A | _ | 1.2 | 2 | |
| | | V_{GS} = 10 V, I_{D} = 500 mA, T_{C} = 125°C | | - | 2 | 3.5 | |
| | | V _{GS} = 5 V, I _D = 50 mA | | _ | 1.7 | 3 | |
| | | $V_{GS} = 5 \text{ V}, I_D = 50 \text{ mA},$ $T_C = 125^{\circ}\text{C}$ | | - | 2.8 | 5 | |
| V _{DS(on)} | Drain-Source On-Voltage | V _{GS} = 10 V, I _D = 500 mA | 2N7000 | _ | 0.6 | 2.5 | V |
| | | V _{GS} = 4.5 V, I _D = 75 mA | | _ | 0.14 | 0.4 | |
| | | V _{GS} = 10 V, I _D = 500 mA | 2N7002 | _ | 0.6 | 3.75 | |
| | | $V_{GS} = 5.0 \text{ V}, I_D = 50 \text{ mA}$ | | _ | 0.09 | 1.5 | |
| | | V _{GS} = 10 V, I _D = 500 mA | NDS7002A | _ | 0.6 | 1 | |
| | | V _{GS} = 5.0 V, I _D = 50 mA | | _ | 0.09 | 0.15 | |
| I _{D(on)} | On-State Drain Current | V _{GS} = 4.5 V, V _{DS} = 10 V | 2N7000 | 75 | 600 | - | mA |
| | | V_{GS} = 10 V, $V_{DS} \ge 2 V_{DS(on)}$ | 2N7002 | 500 | 2700 | - | |
| | | V_{GS} = 10 V, $V_{DS} \ge 2 V_{DS(on)}$ | NDS7002A | 500 | 2700 | - | |
| 9FS | Forward Transconductance | V _{DS} = 10 V, I _D = 200 mA | 2N7000 | 100 | 320 | - | mS |
| | | $V_{DS} \ge 2 V_{DS(on)}, I_D = 200 \text{ mA}$ | 2N7002 | 80 | 320 | - | |
| | | $V_{DS} \ge 2 V_{DS(on)}, I_D = 200 \text{ mA}$ | NDS7002A | 80 | 320 | - | |
| YNAMIC CI | HARACTERISTICS | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz | All | - | 20 | 50 | pF |
| C _{oss} | Output Capacitance |] 1 = 1.0 WINZ | All | - | 11 | 25 | |
| C _{rss} | Reverse Transfer Capacitance | | All | - | 4 | 5 | |
| t _{on} | Turn-On Time | V_{DD} = 15 V, R_{L} = 25 Ω , I_{D} = 500 mA, V_{GS} = 10 V, R_{GEN} = 25 Ω | 2N7000 | - | _ | 10 | ns |
| | | $\begin{split} &V_{DD}=30 \text{ V, R}_{L}=150 \Omega,\\ &I_{D}=200 \text{ mA, V}_{GS}=10 \text{ V,}\\ &R_{GEN}=25 \Omega \end{split}$ | 2N7002 NDS7002A | - | _ | 20 | |
| t _{off} | Turn-Off Time | V_{DD} = 15 V, R_{L} = 25 Ω , I_{D} = 500 mA, V_{GS} = 10 V, R_{GEN} = 25 Ω | 2N7000 | - | _ | 10 | ns |
| | | $\begin{aligned} &V_{DD} = 30 \text{ V, } R_L = 150 \Omega, \\ &I_D = 200 \text{ mA, } V_{GS} = 10 \text{ V,} \\ &R_{GEN} = 25 \Omega \end{aligned}$ | 2N7002 NDS7002A | - | _ | 20 | |

ELECTRICAL CHARACTERISTICS (continued)

Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | Conditions | Туре | Min | Тур | Max | Unit | | | | |
|-----------------|--|--|----------|-----|------|-----|------|--|--|--|--|
| DRAIN-SOU | DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS | | | | | | | | | | |
| I _S | Maximum Continuous Drain-Sou | 2N7002 | - | _ | 115 | mA | | | | | |
| | | NDS7002A | - | _ | 280 | | | | | | |
| I _{SM} | Maximum Pulsed Drain-Source | 2N7002 | - | _ | 0.8 | Α | | | | | |
| | | | NDS7002A | ı | _ | 1.5 | | | | | |
| V _{SD} | Drain-Source Diode Forward Voltage | $V_{GS} = 0 \text{ V, } I_{S} = 115 \text{ mA}$ (Note 1) | 2N7002 | _ | 0.88 | 1.5 | ٧ | | | | |
| | | $V_{GS} = 0 \text{ V, } I_{S} = 400 \text{ mA}$ (Note 1) | NDS7002A | П | 0.88 | 1.2 | | | | | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

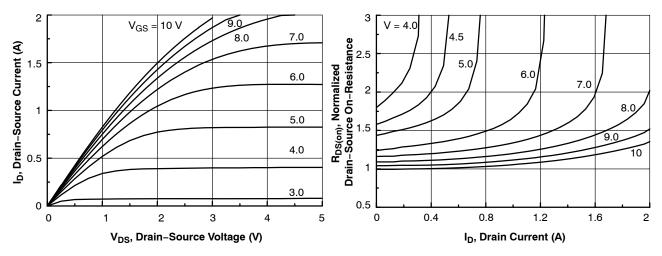


Figure 1. On-Region Characteristics

Figure 2. On–Resistance Variation with Gate Voltage and Drain Current

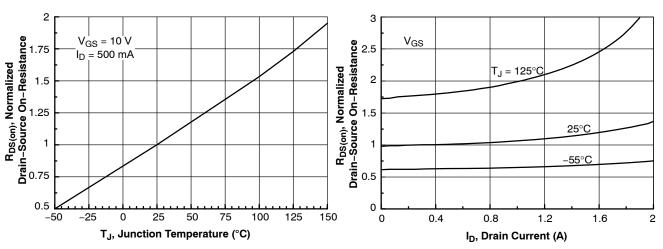


Figure 3. On–Resistance Variation with Temperature

Figure 4. On–Resistance Variation with Drain Current and Temperature

^{1.} Pulse test: Pulse Width ≤ 300 μs, Duty Cycel ≤ 2 %

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

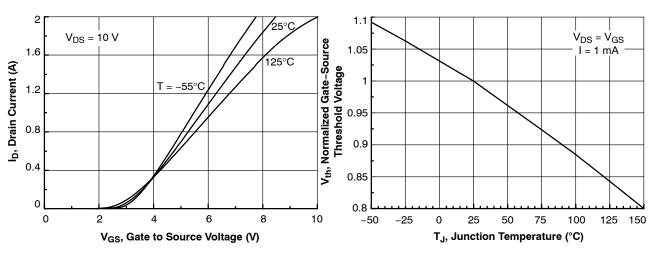


Figure 5. Transfer Characteristics

Figure 6. Gate Threshold Variation with Temperature

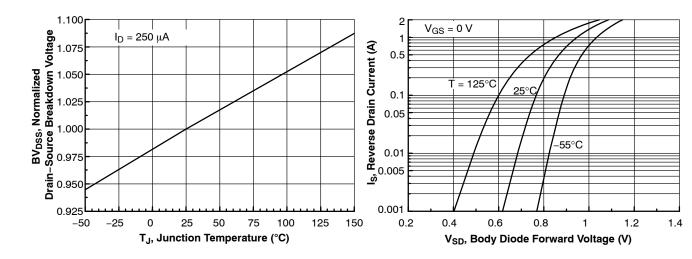


Figure 7. Breakdown Voltage Variation with Temperature

Figure 8. Body Diode Forward Voltage Variation with

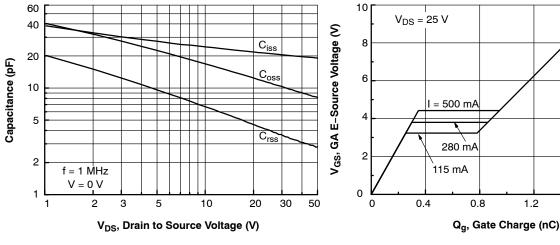


Figure 9. Capacitance Characteristics

Figure 10. Gate Charge Characteristics

1.6

2

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

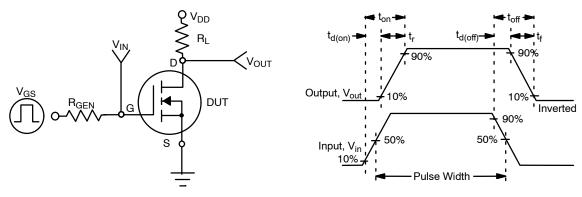


Figure 11. Switching Test Circuit

Figure 12. Switching Waveforms

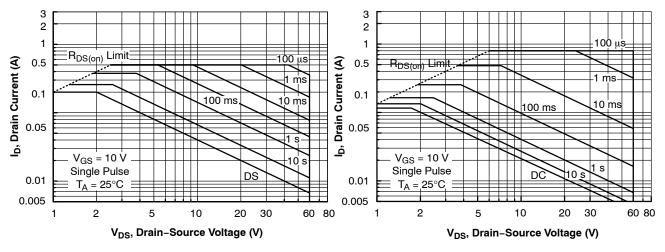


Figure 13. 2N7000 Maximum Safe Operating Area

Figure 14. 2N7002 Maximum Safe Operating Area

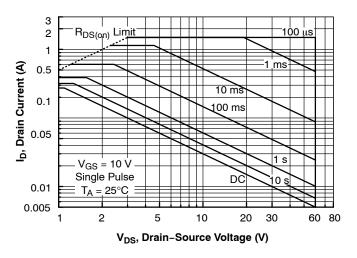


Figure 15. NDS7000A Maximum Safe Operating Area

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

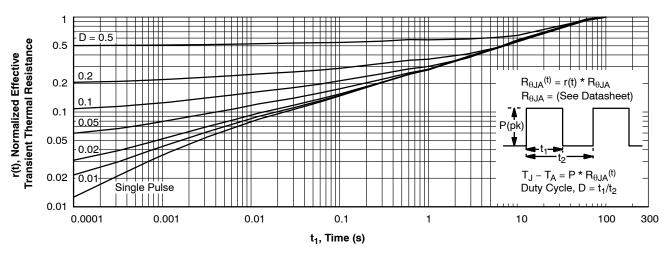


Figure 16. TO-92, 2N7000 Transient Thermal Response Curve

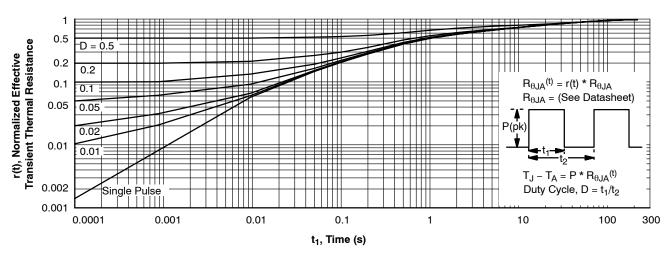


Figure 17. SOT-23, 2N7002 / NDS7002A Transient Thermal Response Curve

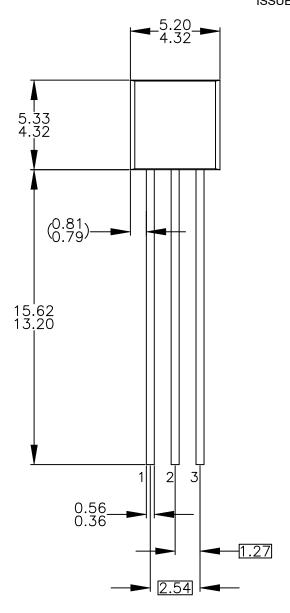
ORDERING INFORMATION

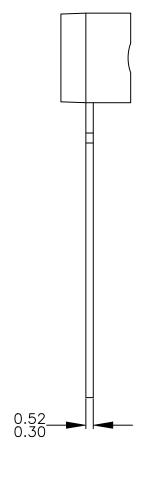
| Part Number | Marking | Package | Packing Method [†] | Min Order Qty / Immediate Pack Qty |
|-------------|---------|-----------|-----------------------------|---------------------------------------|
| 2N7000 | 2N7000 | TO-92 3L | Bulk | 10000 / 1000 |
| 2N7000-D74Z | | (Pb-Free) | Ammo | 2000 / 2000 |
| 2N7000-D75Z | | | Tape and Reel | 2000 / 2000 |
| 2N7000-D26Z | | | | 2000 / 2000 |
| 2N7002 | 702 | SOT-23 3L | Tape and Reel | 3000 / 3000 |
| NDS7002A | 712 | (Pb-Free) | | 3000 / 3000 |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TO-92 3 4.825x4.76 CASE 135AN ISSUE O

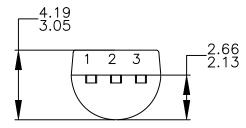
DATE 31 JUL 2016





NOTES: UNLESS OTHERWISE SPECIFIED

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- ALL DIMENSIONS ARE IN MILLIMETERS.
 DRAWING CONFORMS TO ASME Y14.5M—2009.



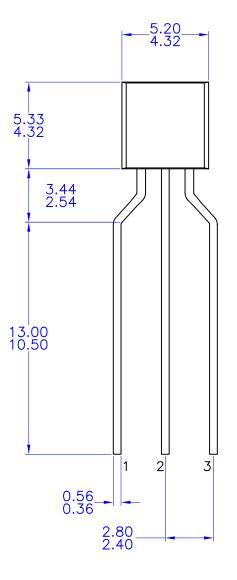
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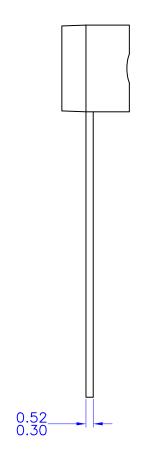
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CASE 135AR ISSUE O

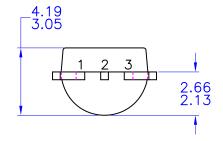
DATE 30 SEP 2016





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- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DRAWING CONFORMS TO ASME Y14.5M-1994



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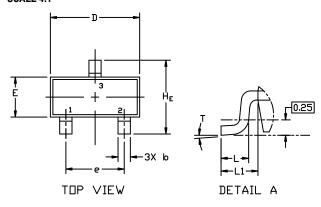


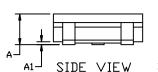


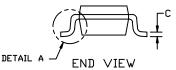
SOT-23 (TO-236) **CASE 318 ISSUE AT**

DATE 01 MAR 2023









NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M,1994.
- CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN. | N□M. | MAX. | MIN. | N□M. | MAX. |
| Α | 0.89 | 1.00 | 1.11 | 0.035 | 0.039 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.017 | 0.020 |
| U | 0.08 | 0.14 | 0.20 | 0.003 | 0.006 | 0.008 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| Ε | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| Ą | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.080 |
| Г | 0.30 | 0.43 | 0.55 | 0.012 | 0.017 | 0.022 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.027 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| Т | 0* | | 10* | 0* | | 10° |

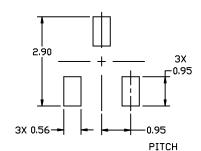
GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package



RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

STYLES ON PAGE 2

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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



SOT-23 (TO-236) CASE 318 ISSUE AT

DATE 01 MAR 2023

| STYLE 1 THRU 5: CANCELLED | STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR | STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR | STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE | ı | |
|---|---|---|--|------------------|------------------|
| STYLE 9: | STYLE 10: | STYLE 11: | STYLE 12: PIN 1. CATHODE 2. CATHODE 3. ANODE | STYLE 13: | STYLE 14: |
| PIN 1. ANODE | PIN 1. DRAIN | PIN 1. ANODE | | PIN 1. SOURCE | PIN 1. CATHODE |
| 2. ANODE | 2. SOURCE | 2. CATHODE | | 2. DRAIN | 2. GATE |
| 3. CATHODE | 3. GATE | 3. CATHODE-ANODE | | 3. GATE | 3. ANODE |
| STYLE 15: | STYLE 16: | STYLE 17: | STYLE 18: | STYLE 19: | STYLE 20: |
| PIN 1. GATE | PIN 1. ANODE | PIN 1. NO CONNECTION | PIN 1. NO CONNECTION | I PIN 1. CATHODE | PIN 1. CATHODE |
| 2. CATHODE | 2. CATHODE | 2. ANODE | 2. CATHODE | 2. ANODE | 2. ANODE |
| 3. ANODE | 3. CATHODE | 3. CATHODE | 3. ANODE | 3. CATHODE-ANODE | 3. GATE |
| STYLE 21: | STYLE 22: | STYLE 23: | STYLE 24: | STYLE 25: | STYLE 26: |
| PIN 1. GATE | PIN 1. RETURN | PIN 1. ANODE | PIN 1. GATE | PIN 1. ANODE | PIN 1. CATHODE |
| 2. SOURCE | 2. OUTPUT | 2. ANODE | 2. DRAIN | 2. CATHODE | 2. ANODE |
| 3. DRAIN | 3. INPUT | 3. CATHODE | 3. SOURCE | 3. GATE | 3. NO CONNECTION |
| STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE | STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE | | | | |

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